PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tatsushi SANO	06/16/2008

RECEIVING PARTY DATA

Name:	SONY CORPORATION
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	Japan
Postal Code:	108-0075

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12143207	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 328290US8

NAME OF SUBMITTER: Ronald Turner

Total Attachments: 1

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PATENT REEL: 021133 FRAME: 0483

	Docket Number:
ASSIGNMENT	
WHEREAS, I, as a below named inventor, residing at the ad only one name is listed below) or a joint inventor (if plural names are listed be PLL CIRCUIT, RECORDING APPARATUS, AND CLOCK-SIGNAL GE	elow) of certain new and useful improvements in
for which application for Letters Patent of the United States of America was exand address;	ecuted by me on the date indicated next to my name
AND WHEREAS, Sony Corporation, a Japanese corporation Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all said application disclosing the invention and in, to and under any Letters Pater therefor in the United States and in any and all foreign countries;	interest in, to and under said invention,
NOW THEREFORE, in consideration of the sum of One Dollar the receipt and sufficience of which are hereby acknowledged, I, as a sole or join hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns interest in the said invention, said application, including any divisions and compatent of the United States, and countries foreign thereto, which may be granted rights and/or convention rights under the International Convention for the Protecti Relating to Patents, Designs and Industrial Models, and any other international adheres, and to any other benefits accruing or to accrue to me with respect to patents in the United States and countries foreign thereto, and I hereby authorize said United States Letters Patent to said ASSIGNEE, as the assignee of the whole the said accountries of the said accountries of the whole the said accountries of the said accountries of the whole the said accountries of the said accountries of the whole the said accountries of th	int inventor as indicated below, by these presents do s, and legal representatives, the entire right, title and itinuations thereof, and in and to any and all Letters for said invention, and in and to any and all priority on of Industrial Property, Inter-American Convention I agreements to which the United States of America the filing of applications for patents or securing of and request the Commissioner of Patents to issue the
And I further agree to execute all necessary or desirable and lawful f ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal and without further remuneration, in order to perfect title in said invention, applications and Letters Patent of the United States and countries foreign thereto	representatives may from time-to-time present to me modifications, and improvements in said invention,
And I further agree to properly execute and deliver and without further papers for application for foreign patents, for filing subdivisions of said applications of any Letters Patent which may be granted for my aforesaid invention, prepare at its own expense;	ation for patent, and or, for obtaining any reissue or
And I further agree that ASSIGNEE will, upon its request, be provided relating to said application, said invention and said Letters Patent and legal equaccessible to me and will testify as to the same in any interference or litigation	uivalents in foreign countries as may be known and
And I hereby covenant that no assignment, sale, agreement or encumbr would conflict with this assignment and sale.	rance has been or will be made or entered into which
And I hereby authorize and request my attorney(s) of record in this app this application in the spaces that follow: Serial Number:	olication to insert the serial number and filing date of Filing Date:
This assignment executed on the dates indicated below.	
Tatsushi SANO	June, 16, 2008
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
Tataushi Sano	June. 16, 2008
Signature of first or sole inventor	Date of this assignment

RECORDED: 06/23/2008

PATENT REEL: 021133 FRAME: 0484